



Material Content Data Sheet				RoHS		Halogen-Free		
Sales Product Name	ICE3AR0680JZ			Issued		20. July 2018		
MA#	MA001117494 PG-DIP-7-4							
Package				Weight*		654.35 mg		
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	12.522	1.91	1.91	19136	19136
leadframe	inorganic material	phosphorus	7723-14-0	0.049	0.01		74	
	non noble metal	zinc	7440-66-6	0.194	0.03		297	
	non noble metal	iron	7439-89-6	3.884	0.59		5936	
	non noble metal	copper	7440-50-8	157.726	24.10	24.73	241043	247350
wire	noble metal	gold	7440-57-5	0.251	0.04	0.04	384	384
encapsulation	organic material	carbon black	1333-86-4	1.405	0.21		2147	
	plastics	epoxy resin	-	45.428	6.94		69426	
	inorganic material	silicondioxide	60676-86-0	421.501	64.43	71.58	644154	715727
leadfinish	non noble metal	tin	7440-31-5	6.460	0.99	0.99	9872	9872
plating	noble metal	silver	7440-22-4	1.911	0.29	0.29	2920	2920
glue	plastics	epoxy resin	-	0.453	0.07		692	
	noble metal	silver	7440-22-4	2.564	0.39	0.46	3919	4611
*deviation	< 10%		Sum in total: 100.00 1000000					

Important Remarks:

- 1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
- 2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
- 3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and does not use any exemption

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